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2812

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al.

Title: SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Docket No.: 303.672US1

Filed: January 18, 2000

Examiner: Ha Nguyen

Serial No.: 09/483,881

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Group Art Unit: 2812

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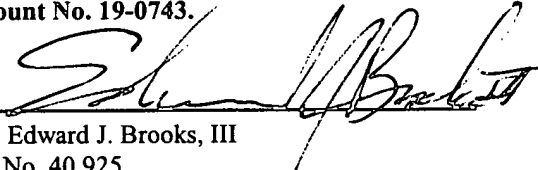
Commissioner for Patents
Washington, D.C. 20231

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- ☒ A Response to Restriction Requirement (1 Page).

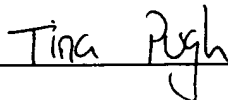
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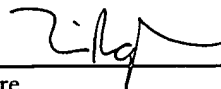
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